Kingbright

KCPSC04-105

Surface Mount Display

DESCRIPTIONS

- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- . It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

FEATURES

- · 0.4 inch character height
- Low current operation
- · High contrast and light output
- · Categorized for luminous intensity
- · Mechanically rugged
- Gray face, white segment
- Package: 400 pcs / reel
- · Moisture sensitivity level: 2a
- · RoHS compliant

APPLICATIONS

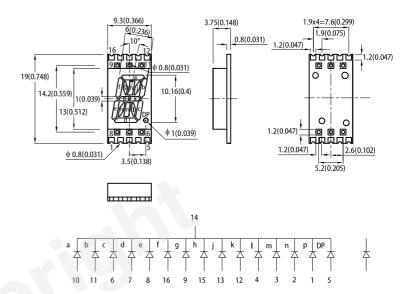
- · Home and smart appliances
- · Display time and digital combination
- · Industrial and instrumental applications
- · Numeric status

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

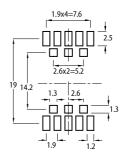


PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units: mm; tolerance: ± 0.15)



- rvotes:

 1. All dimensions are in millimeters (inches), Tolerance is ±0.25(0.01") unless otherwise noted.

 2. The specifications, characteristics and technical data described in the datasheet are subject to
- change without prior notice.

 3. The gap between the reflector and PCB shall not exceed 0.25mm.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (ucd) @ 10mA [1]		Description	
			Min.	Тур.	Description	
KCPSC04-105	■ Hyper Red (AlGaInP)	White Diffused	14000	36000	Common Cathode,	
			*3600	*8300	Rt. Hand Decimal	

Luminous intensity / luminous Flux: +/-15%.
 Luminous intensity value is traceable to CIE127-2007 standards



ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		Unit
Parameter		Emitting Color	Тур.	Max.	UIIIL
Wavelength at Peak Emission I _F = 10mA	λ_{peak}	Hyper Red	645	-	nm
Dominant Wavelength I _F = 10mA	λ_{dom} [1]	Hyper Red	630	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 10mA	Δλ	Hyper Red	28	-	nm
Capacitance	С	Hyper Red	35	-	pF
Forward Voltage I _F = 10mA	V _F ^[2]	Hyper Red	1.85	2.35	V
Reverse Current (V _R = 5V)	I _R	Hyper Red	_	10	μΑ

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Symbol	Value	Unit
Power Dissipation	P _D	75	mW
Reverse Voltage	V _R	5	V
Junction Temperature	Tj	115	°C
Operating Temperature	T _{op}	-40 to +85	°C
Storage Temperature	T _{stg}	-40 to +85	°C
DC Forward Current	I _F	30	mA
Peak Forward Current	I _{FM} ^[1]	185	mA
Electrostatic Discharge Threshold (HBM)	-	3000	V

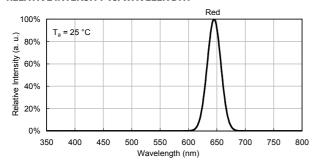
^{1.} The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd:±1nm.)
2. Forward voltage: ±0.1V.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

Kingbright

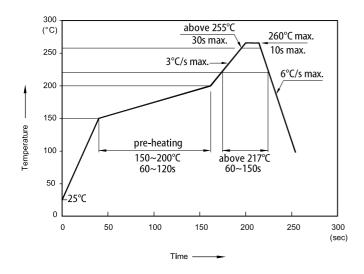
TECHNICAL DATA

RELATIVE INTENSITY vs. WAVELENGTH



HYPER RED Forward Current vs. Luminous Intensity vs. Forward Current Derating Curve Luminous Intensity vs. Forward Voltage **Forward Current Ambient Temperature** 20 2.5 2.5 50 _uminous intensity normalised at Luminous intensity normalised at forward current (mA) T_a = 25 °C T_a = 25 °C Forward current (mA) 2.0 16 40 2.0 12 30 1.5 1.5 10 mA $T_a = 25$ 1.0 8 1.0 20 Permissible 0.5 10 0.5 0.0 0.0 2.1 -20 0 20 40 60 80 100 -40 -20 0 20 40 60 80 100 1.8 2.0 0 16 1.9 8 12 -40 1.6 Forward voltage (V) Forward current (mA) Ambient temperature (°C) Ambient temperature (°C)

REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS



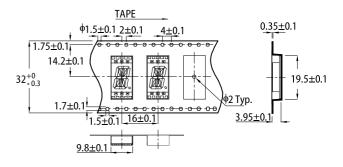
- Notes:

 1. Don't cause stress to the LEDs while it is exposed to high temperature.

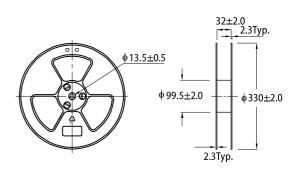
 2. The maximum number of reflow soldering passes is 2 times.

 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

TAPE SPECIFICATIONS (units: mm)



REEL DIMENSION (units: mm)



Kingbright

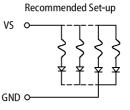
PACKING & LABEL SPECIFICATIONS

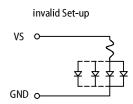




CIRCUIT DESIGN NOTES

- 1. Protective current-limiting resistors may be necessary to operate the LEDs within the specified range.
- 2. LEDs mounted in parallel should each be placed in series with its own current-limiting resistor.
- 3. The driving circuit should be designed to protect the LED against reverse voltages and transient voltage spikes when the circuit is powered up or shut down.
- 4. The safe operating current should be chosen after considering the maximum ambient temperature of the operating environment.
- 5. Prolonged reverse bias should be avoided, as it could cause metal migration, leading to an increase in leakage current or causing a short circuit.





PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If
- when any special process such as potting is required for LED assembly, please consult with Kingbright representative before proceeding.

- All design applications should refer to Kingbright application notes available at h